

WATER-SOLUBLE POLYIMIDE PRECURSOR,  
AQUEOUS POLYIMIDE PRECURSOR SOLUTION, POLYIMIDE,  
IMPREGNATED MATERIAL WITH POLYIMIDE BINDER, AND LAMINATE

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ABSTRACT OF THE DISCLOSURE

10           A water-soluble polyimide precursor, which can be  
suitably applied for aromatic polyimides and exhibits a  
low reduction in heat resistance and mechanical  
properties, an aqueous solution of the polyimide  
precursor and a polyimide obtained from the precursor. A  
15   heat-resistant fiber impregnated material and an  
impregnated sheet-like material are prepared by using the  
precursor and a laminate is prepared by employing the  
precursor.